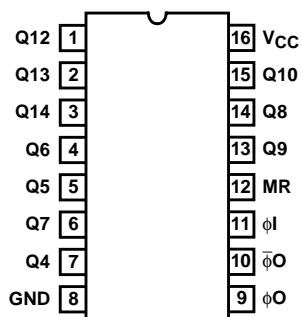


Features

- Onboard Oscillator
- Common Reset
- Negative Edge Clocking
- Typical $f_{MAX} = 50\text{MHz}$ at $V_{CC} = 5\text{V}$, $C_L = 15\text{pF}$, $T_A = 25^\circ\text{C}$
- Fanout (Over Temperature Range)
 - Standard Outputs 10 LSTTL Loads
 - Bus Driver Outputs 15 LSTTL Loads
- Wide Operating Temperature Range ... -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
 - 2V to 6V Operation
 - High Noise Immunity: $N_{IL} = 30\%$, $N_{IH} = 30\%$ of V_{CC} at $V_{CC} = 5\text{V}$
- HCT Types
 - 4.5V to 5.5V Operation
 - Direct LSTTL Input Logic Compatibility, $V_{IL} = 0.8\text{V}$ (Max), $V_{IH} = 2\text{V}$ (Min)
 - CMOS Input Compatibility, $I_I \leq 1\mu\text{A}$ at V_{OL}, V_{OH}

Pinout

CD74HC4060, CD74HCT4060
(PDIP, SOIC)
TOP VIEW



Description

The Harris CD74HC4060 and CD74HCT4060 each consist of an oscillator section and 14 ripple-carry binary counter stages. The oscillator configuration allows design of either RC or crystal oscillator circuits. A Master Reset input is provided which resets the counter to the all-0's state and disables the oscillator. A high level on the MR line accomplishes the reset function. All counter stages are master-slave flip-flops. The state of the counter is advanced one step in binary order on the negative transition of ϕ_1 (and ϕ_0). All inputs and outputs are buffered. Schmitt trigger action on the input-pulse-line permits unlimited rise and fall times.

In order to achieve a symmetrical waveform in the oscillator section the HCT4060 input pulse switch points are the same as in the HC4060; only the MR input in the HCT4060 has

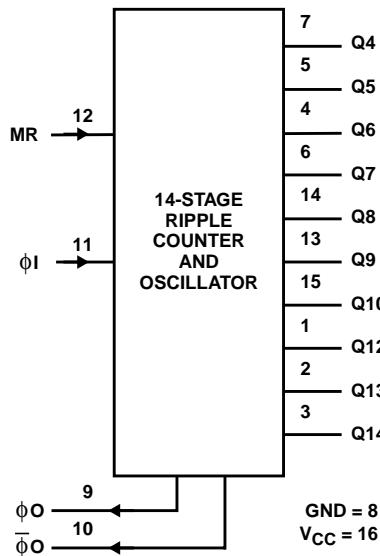
TTL switching levels.

Ordering Information

| PART NUMBER | TEMP. RANGE ($^{\circ}$ C) | PACKAGE | PKG. NO. |
|--------------|-----------------------------|------------|----------|
| CD74HC4060E | -55 to 125 | 16 Ld PDIP | E16.3 |
| CD74HCT4060E | -55 to 125 | 16 Ld PDIP | E16.3 |
| CD74HC4060M | -55 to 125 | 16 Ld SOIC | M16.15 |
| CD74HCT4060M | -55 to 125 | 16 Ld SOIC | M16.15 |

NOTES:

1. When ordering, use the entire part number. Add the suffix 96 to obtain the variant in the tape and reel.
2. Wafer and die for this part number is available which meets all electrical specifications. Please contact your local sales office or Harris customer service for ordering information.

Functional Diagram

CD74HC4060, CD74HCT4060

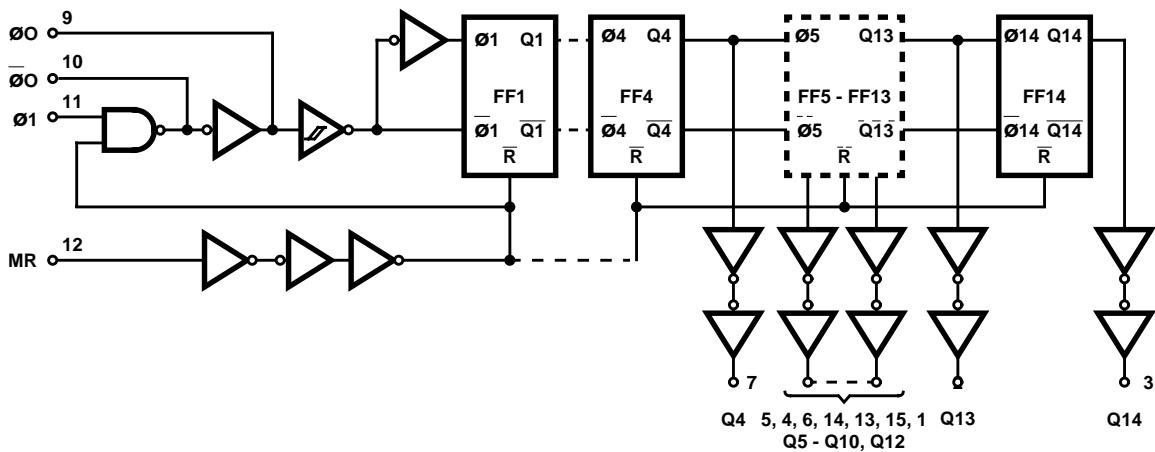


FIGURE 1. LOGIC BLOCK DIAGRAM

TRUTH TABLE

| ϕI | MR | OUTPUT STATE |
|----------|----|-----------------------|
| ↑ | L | No Change |
| ↓ | L | Advance to Next State |
| X | H | All Outputs are Low |

CD74HC4060, CD74HCT4060

Absolute Maximum Ratings

| | | |
|---|-------|-------------|
| DC Supply Voltage, V _{CC} | | -0.5V to 7V |
| DC Input Diode Current, I _{IK} | | |
| For V _I < -0.5V or V _I > V _{CC} + 0.5V | | ±20mA |
| DC Output Diode Current, I _{OK} | | |
| For V _O < -0.5V or V _O > V _{CC} + 0.5V | | ±20mA |
| DC Drain Current, per Output, I _O | | |
| For -0.5V < V _O < V _{CC} + 0.5V | | ±25mA |
| DC V _{CC} or Ground Current, I _{CC} | | ±50mA |

Thermal Information

| | |
|--|------------------------|
| Thermal Resistance (Typical, Note 3) | θ _{JA} (°C/W) |
| PDIP Package | |
| SOIC Package | |
| Maximum Junction Temperature | |
| Maximum Storage Temperature Range | |
| Maximum Lead Temperature (Soldering 10s) | |
| (SOIC - Lead Tips Only) | 300°C |

Operating Conditions

| | | |
|---|-------|-----------------------|
| Temperature Range, T _A | | -55°C to 125°C |
| Supply Voltage Range, V _{CC} | | |
| HC Types | | .2V to 6V |
| HCT Types | | .4.5V to 5.5V |
| DC Input or Output Voltage, V _I , V _O | | 0V to V _{CC} |
| Input Rise and Fall Time | | |
| 2V | | 1000ns (Max) |
| 4.5V | | 500ns (Max) |
| 6V | | 400ns (Max) |

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

3. θ_{JA} is measured with the component mounted on an evaluation PC board in free air.

DC Electrical Specifications

| PARAMETER | SYMBOL | TEST CONDITIONS | | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS | |
|---|-----------------|------------------------------------|---------------------|------------------------|------|-----|------|---------------|------|----------------|------|-------|--|
| | | V _I (V) | I _O (mA) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | | |
| HC TYPES | | | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 2 | 1.5 | - | - | 1.5 | - | 1.5 | - | V | |
| | | | | 4.5 | 3.15 | - | - | 3.15 | - | 3.15 | - | V | |
| | | | | 6 | 4.2 | - | - | 4.2 | - | 4.2 | - | V | |
| Low Level Input Voltage | V _{IL} | - | - | 2 | - | - | 0.5 | - | 0.5 | - | 0.5 | V | |
| | | | | 4.5 | - | - | 1.35 | - | 1.35 | - | 1.35 | V | |
| | | | | 6 | - | - | 1.8 | - | 1.8 | - | 1.8 | V | |
| High Level Output Voltage Q Outputs CMOS Loads | V _{OH} | V _{IH} or V _{IL} | -0.02 | 2 | 1.9 | - | - | 1.9 | - | 1.9 | - | V | |
| | | | -0.02 | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V | |
| | | | -0.02 | 6 | 5.9 | - | - | 5.9 | - | 5.9 | - | V | |
| High Level Output Voltage Q Outputs TTL Loads | | | - | - | - | - | - | - | - | - | - | V | |
| | | | -4 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V | |
| | | | -5.2 | 6 | 5.48 | - | - | 5.34 | - | 5.2 | - | V | |
| Low Level Output Voltage Q Outputs CMOS Loads | V _{OL} | V _{IH} or V _{IL} | 0.02 | 2 | - | - | 0.1 | - | 0.1 | - | 0.1 | V | |
| | | | 0.02 | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V | |
| | | | 0.02 | 6 | - | - | 0.1 | - | 0.1 | - | 0.1 | V | |
| Low Level Output Voltage Q Outputs TTL Loads | | | - | - | - | - | - | - | - | - | - | V | |
| | | | 4 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V | |
| | | | 5.2 | 6 | - | - | 0.26 | - | 0.33 | - | 0.4 | V | |
| High-Level Output Voltage \bar{O} Output (Pin 10) CMOS Loads | V _{OH} | V _{CC} or GND | -0.02 | 2 | 1.9 | - | - | 1.9 | - | 1.9 | - | V | |
| | | | -0.02 | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V | |
| | | | -0.02 | 6 | 5.9 | - | - | 5.9 | - | 5.9 | - | V | |

CD74HC4060, CD74HCT4060

DC Electrical Specifications (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|--|-----------------|---|---------------------|------------------------|------|-----|------|---------------|------|----------------|-----|-------|
| | | V _I (V) | I _O (mA) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| High-Level Output Voltage \bar{Q} Output (Pin 10) TTL Loads Note 6 | V _{OH} | V _{CC} or GND | -2.6 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| | | | -3.3 | 6 | 5.48 | - | - | 5.34 | - | 5.2 | - | V |
| Low-Level Output Voltage \bar{Q} Output (Pin 10) CMOS Loads | V _{OL} | V _{CC} or GND | 0.02 | 2 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.02 | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 0.02 | 6 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| Low-Level Output Voltage \bar{Q} Output (Pin 10) TTL Loads | V _{OL} | V _{CC} or GND | 2.6 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| | | | 3.3 | 6 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| High-Level Output Voltage \bar{Q} Output (Pin 9) TTL Loads | V _{OH} | V _{IL} or V _{IH} | -3.2 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| | | | -4.2 | 6 | 5.48 | - | - | 5.34 | - | 5.2 | - | V |
| Low-Level Output Voltage \bar{Q} Output (Pin 9) TTL Loads | V _{OL} | V _{IL} or V _{IH} | -2.6 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| | | | -3.3 | 6 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| Input Leakage Current | I _I | V _{CC} or GND | - | 6 | - | - | ±0.1 | - | ±1 | - | ±1 | μA |
| Quiescent Device Current | I _{CC} | V _{CC} or GND | 0 | 6 | - | - | 8 | - | 80 | - | 160 | μA |
| HCT TYPES | | | | | | | | | | | | |
| High Level Input Voltage | V _{IH} | - | - | 4.5 to 5.5 | 2 | - | - | 2 | - | 2 | - | V |
| Low Level Input Voltage | V _{IL} | - | - | 4.5 to 5.5 | - | - | 0.8 | - | 0.8 | - | 0.8 | V |
| High Level Output Voltage Q Outputs CMOS Loads | V _{OH} | V _{IH} or V _{IL} Note 5 | -0.02 | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V |
| | | | -4 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| Low Level Output Voltage Q Outputs CMOS Loads | V _{OL} | V _{IH} or V _{IL} Note 5 | 0.02 | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |
| | | | 4 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| High-Level Output Voltage \bar{Q} Output (Pin 10) CMOS Loads | V _{OH} | V _{CC} or GND | -0.02 | 4.5 | 4.4 | - | - | 4.4 | - | 4.4 | - | V |
| | | | -2.6 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| Low-Level Output Voltage \bar{Q} Output (Pin 10) CMOS Loads Note 6 | V _{OL} | V _{CC} or GND | 0.02 | 4.5 | - | - | 0.1 | - | 0.1 | - | 0.1 | V |

CD74HC4060, CD74HCT4060

DC Electrical Specifications (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|--|--------------------------|---|---------------------|---------------------|------|-----|-----------|---------------|---------|----------------|---------|---------|
| | | V _I (V) | I _O (mA) | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| Low-Level Output Voltage \bar{O}_O Output (Pin 10) TTL Loads | V _{OL} | V _{CC} or GND | 2.6 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| High-Level Output Voltage ϕ_O Output (Pin 9) TTL Loads | V _{OH} | V _{IL} or V _{IH} | -3.2 | 4.5 | 3.98 | - | - | 3.84 | - | 3.7 | - | V |
| Low-Level Output Voltage ϕ_O Output (Pin 9) TTL Loads | V _{OL} | V _{IH} or V _{IL} Note 5 | 3.2 | 4.5 | - | - | 0.26 | - | 0.33 | - | 0.4 | V |
| Input Leakage Current | I _I | Any Voltage Between V _{CC} and GND | 0 | 5.5 | - | - | ± 0.1 | - | ± 1 | - | ± 1 | μA |
| Quiescent Device Current | I _{CC} | V _{CC} or GND | 0 | 5.5 | - | - | 8 | - | 80 | - | 160 | μA |
| Additional Quiescent Device Current Per Input Pin: 1 Unit Load | ΔI_{CC} (Note 4) | V _{CC} -2.1 | - | 4.5 to 5.5 | - | 100 | 360 | - | 450 | - | 490 | μA |

NOTES:

4. For dual-supply systems theoretical worst case ($V_I = 2.4V$, $V_{CC} = 5.5V$) specification is 1.8mA.
5. For pin 11 $V_{IH} = 3.15V$, $V_{IL} = 0.9V$.
6. Limits not valid when pin 12 (instead of pin 11) is used as control input.

HCT Input Loading Table

| INPUT | UNIT LOADS |
|-------|------------|
| MR | 0.35 |

NOTE: Unit Load is ΔI_{CC} limit specified in DC Electrical Specifications Table, e.g. 360 μA max at 25°C.

Prerequisite for Switching Specifications

| PARAMETER | SYMBOL | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | | -55°C TO 125°C | | | UNITS |
|-------------------------------|------------------|---------------------|------|-----|-----|---------------|-----|-----|----------------|-----|-----|-------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| HC TYPES | | | | | | | | | | | | |
| Maximum Input Pulse Frequency | t _{MAX} | 2 | 6 | - | - | 5 | - | - | 4 | - | - | MHz |
| | | 4.5 | 30 | - | - | 25 | - | - | 20 | - | - | MHz |
| | | 6 | 35 | - | - | 29 | - | - | 23 | - | - | MHz |
| Input Pulse Width | t _W | 2 | 80 | - | - | 100 | - | - | 120 | - | - | ns |
| | | 4.5 | 16 | - | - | 20 | - | - | 24 | - | - | ns |
| | | 6 | 14 | - | - | 17 | - | - | 20 | - | - | ns |
| Reset Removal Time | t _{REM} | 2 | 100 | - | - | 125 | - | - | 150 | - | - | ns |
| | | 4.5 | 20 | - | - | 25 | - | - | 30 | - | - | ns |
| | | 6 | 17 | - | - | 21 | - | - | 26 | - | - | ns |

CD74HC4060, CD74HCT4060

Prerequisite for Switching Specifications (Continued)

| PARAMETER | SYMBOL | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | | -55°C TO 125°C | | | UNITS |
|--------------------------------|------------------|---------------------|------|-----|-----|---------------|-----|-----|----------------|-----|-----|-------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | MIN | TYP | MAX | |
| Reset Pulse Width | t _W | 2 | 80 | - | - | 100 | - | - | 120 | - | - | ns |
| | | 4.5 | 16 | - | - | 20 | - | - | 24 | - | - | ns |
| | | 6 | 14 | - | - | 17 | - | - | 20 | - | - | ns |
| HCT TYPES | | | | | | | | | | | | |
| Maximum Input, Pulse Frequency | t _{MAX} | 4.5 | 30 | - | - | 25 | - | - | 20 | - | - | MHz |
| Input Pulse Width | t _W | 4.5 | 16 | - | - | 20 | - | - | 24 | - | - | ns |
| Reset Removal Time | t _{REM} | 4.5 | 26 | - | - | 33 | - | - | 39 | - | - | ns |
| Reset Pulse Width | t _W | 4.5 | 25 | - | - | 31 | - | - | 38 | - | - | ns |

Switching Specifications Input t_r, t_f = 6ns

| PARAMETER | SYMBOL | TEST CONDITIONS | V _{CC} (V) | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | | UNITS |
|-------------------------------------|-------------------------------------|-----------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|-------|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX | |
| HC TYPES | | | | | | | | | | | |
| Propagation Delay φI to Q4 | t _{PLH} , t _{PHL} | C _L = 50pF | 2 | - | - | 300 | - | 375 | - | 450 | ns |
| | | | 4.5 | - | - | 60 | - | 75 | - | 90 | ns |
| | | C _L = 15pF | 5 | - | 25 | - | - | - | - | - | ns |
| | | C _L = 50pF | 6 | - | - | 51 | - | 64 | - | 78 | ns |
| Q _n to Q _{n+1} | t _{PLH} , t _{PHL} | C _L = 50pF | 2 | - | - | 80 | - | 100 | - | 120 | ns |
| | | | 4.5 | - | - | 16 | - | 20 | - | 24 | ns |
| | | C _L = 15pF | 5 | - | 6 | - | - | - | - | - | ns |
| | | C _L = 50pF | 6 | - | - | 14 | - | 17 | - | 20 | ns |
| MR to Q _n | t _{PHL} | C _L = 50pF | 2 | - | - | 175 | - | 220 | - | 265 | ns |
| | | | 4.5 | - | - | 35 | - | 44 | - | 53 | ns |
| | | C _L = 15pF | 5 | - | 14 | - | - | - | - | - | ns |
| | | C _L = 50pF | 6 | - | - | 30 | - | 37 | - | 45 | ns |
| Output Transition Time | t _{THL} , t _{TLH} | C _L = 50pF | 2 | - | - | 75 | - | 95 | - | 110 | ns |
| | | | 4.5 | - | - | 15 | - | 19 | - | 22 | ns |
| | | | 6 | - | - | 13 | - | 16 | - | 19 | ns |
| Input Capacitance | C _I (TBD) | | | | | | | | | | |
| Propagation Dissipation Capacitance | C _{PD} | - | - | - | 40 | - | - | - | - | - | pF |
| HCT TYPES | | | | | | | | | | | |
| Propagation Delay φI to Q4 | t _{PLH} , t _{PHL} | C _L = 50pF | 2 | - | - | - | - | - | - | - | -ns |
| | | | 4.5 | - | - | 66 | - | 83 | - | 100 | ns |
| | | C _L = 15pF | 5 | - | 25 | - | - | - | - | - | -ns |
| | | C _L = 50pF | 6 | - | - | - | - | - | - | - | -ns |

CD74HC4060, CD74HCT4060

Switching Specifications Input $t_r, t_f = 6\text{ns}$ (Continued)

| PARAMETER | SYMBOL | TEST CONDITIONS | $V_{CC} (\text{V})$ | 25°C | | | -40°C TO 85°C | | -55°C TO 125°C | |
|-------------------------------------|--------------------|---------------------|---------------------|------|-----|-----|---------------|-----|----------------|-----|
| | | | | MIN | TYP | MAX | MIN | MAX | MIN | MAX |
| Q_n to Q_{n+1} | t_{PLH}, t_{PHL} | $C_L = 50\text{pF}$ | 2 | - | - | - | - | - | - | - |
| | | | 4.5 | - | - | 16 | - | 20 | - | 24 |
| | | $C_L = 15\text{pF}$ | 5 | - | 6 | - | - | - | - | - |
| | | $C_L = 50\text{pF}$ | 6 | - | - | - | - | - | - | - |
| MR to Q_n | t_{PHL} | $C_L = 50\text{pF}$ | 2 | - | - | - | - | - | - | - |
| | | | 4.5 | - | - | 44 | - | 55 | - | 66 |
| | | $C_L = 15\text{pF}$ | 5 | - | 17 | - | - | - | - | - |
| | | $C_L = 50\text{pF}$ | 6 | - | - | - | - | - | - | - |
| Output Transition Time | t_{THL}, t_{TLH} | $C_L = 50\text{pF}$ | 2 | - | - | - | - | - | - | - |
| | | | 4.5 | - | - | 15 | - | 19 | - | 22 |
| | | | 6 | - | - | - | - | - | - | - |
| Input Capacitance | C_I (TBD) | | | | | | | | | |
| Propagation Dissipation Capacitance | C_{PD} | - | - | - | 40 | - | - | - | - | pF |

NOTES:

7. C_{PD} is used to determine the dynamic power consumption, per package.

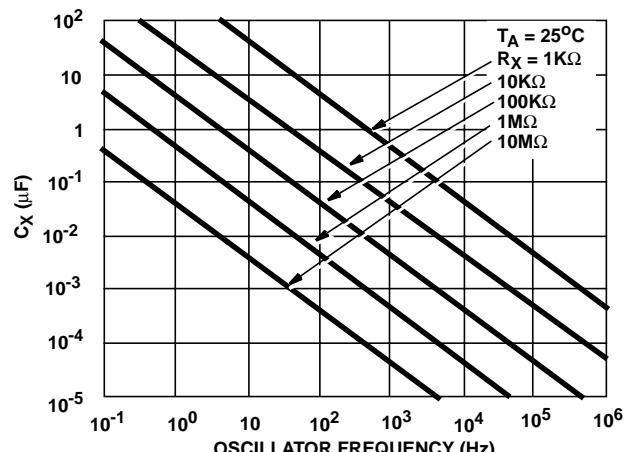
8. $P_D = C_{PD} V_{CC}^2 f_i \sum (C_L V_{CC}^2 f_i / M)$ where $M = 2^1, 2^2, 2^3, \dots, 2^{14}$, f_i = input frequency, C_L = output load capacitance.

TYPICAL LIMIT VALUES FOR R_X AND C_X

| PARAMETER | TEST CONDITIONS | VOLTAGE | TYPICAL MAXIMUM LIMITS |
|--------------------------------------|--|---------|------------------------|
| R_X Minimum | $C_X > 1000\text{pF}$ | 2 | 1KΩ |
| | $C_X > 10\text{pF}$ | 4.5 | |
| | $C_X > 10\text{pF}$ | 6 | |
| R_X Maximum | $C_X > 10\text{pF}$ | 2 | 20MΩ |
| | $C_X > 10\text{pF}$ | 4.5 | |
| | $C_X > 10\text{pF}$ | 6 | |
| C_X Minimum | $R_X > 10\text{K}\Omega$ | 2 | 10pF |
| | $R_X > 10\text{K}\Omega$ | 4.5 | |
| | $R_X > 10\text{K}\Omega$ | 6 | |
| | $R_X = 1\text{K}\Omega$ | 2 | 1000pF |
| | $R_X = 1\text{K}\Omega$ | 4.5 | |
| | $R_X = 1\text{K}\Omega$ | 6 | |
| Maximum Astable Oscillator Frequency | $C_X = 1000\text{pF}, R_X = 1\text{K}\Omega$ | 2 | 0.5MHz (Note 9) |
| | $C_X = 100\text{pF}, R_X = 1\text{K}\Omega$ | 4.5 | 3MHz (Note 9) |
| | $C_X = 100\text{pF}, R_X = 1\text{K}\Omega$ | 6 | 3MHz (Note 9) |

NOTE:

9. At very high frequencies $f = 1/2.2 R_X C_X$ no longer gives an accurate approximation.

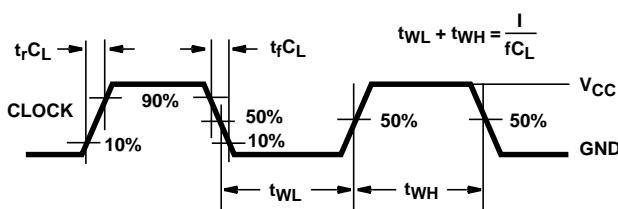


NOTE: OSC Frequency $\approx 1/2.2 R_X C_X$

For $1\text{M}\Omega > R_X > 1\text{K}\Omega, C_X > 10\text{pF}, f < 1\text{MHz}$

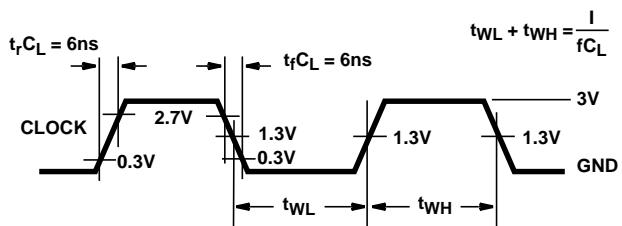
FIGURE 2. FREQUENCY OF ON-BOARD OSCILLATOR AS A FUNCTION OF C_X AND R_X

Typical Performance Curves



NOTE: Outputs should be switching from 10% V_{CC} to 90% V_{CC} in accordance with device truth table. For f_{MAX} , input duty cycle = 50%.

FIGURE 3. HC CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH



NOTE: Outputs should be switching from 10% V_{CC} to 90% V_{CC} in accordance with device truth table. For f_{MAX} , input duty cycle = 50%.

FIGURE 4. HCT CLOCK PULSE RISE AND FALL TIMES AND PULSE WIDTH

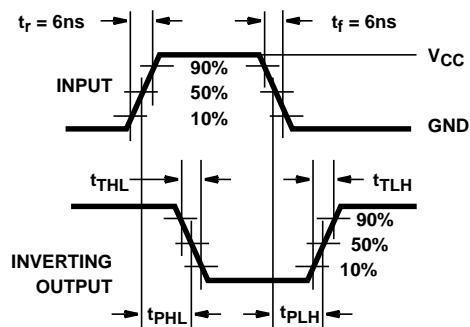


FIGURE 5. HC AND HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

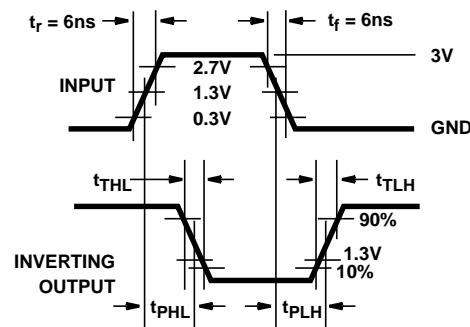


FIGURE 6. HCT TRANSITION TIMES AND PROPAGATION DELAY TIMES, COMBINATION LOGIC

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